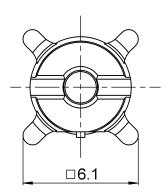
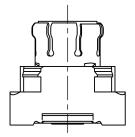


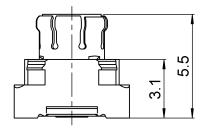


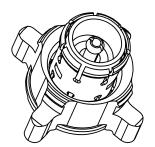
SMT PLUG RECEPTACLE

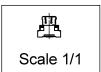
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All dimensions are in mm.



COMPONENTS	MATERIALS	PLATING (μm)
Body Center contact	BERYLLIUM COPPER; BRASS BERYLLIUM COPPER; BRASS	NPGR NPGR
Outer contact	-	
Insulator	PTFE,LCP	
Gasket		
Others parts		
-	-	-
-	-	-



## **Technical Data Sheet**

SMT PLUG RECEPTACLE

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### **PACKAGING**

Standard	Unit	Other
100	Contact us	Contact us

## **ELECTRICAL CHARACTERISTICS**

Ω

Frequency 0-12.4 GHz 0.0000 VSWR 1.065 x F(GHz) Maxi √F(GHz) dB Maxi Insertion loss 0.12 - F(GHz)) dB Maxi RF leakage 100 - ( Voltage rating 330 Veff Maxi Dielectric withstanding voltage 1000 Veff mini Insulation resistance 1000  $M\Omega$  mini

## **SPECIFICATION**

**ENVIRONMENTAL** 

-55/+155

NA

NA

°C

Atm.cm3/s

## MECHANICAL CHARACTERISTICS

Center contact retention

Impedance

Axial force – Mating End

Axial force – Opposite end

Torque

10

N mini

N mini

N mini

N mini

N mini

N mini

Recommended torque

Mating NA N.cm Panel nut NA N.cm

Mating life 100 Cycles mini Weight 0.3960 g

## OTHER CHARACTERISTICS

Assembly instruction:

Operating temperature

Hermetic seal

Panel leakage

Others:

to 2GHz (1.106 --- 2 to 6GHz) Interface MMBX only ,up to 2.5GHz PCB to PCB -45 dB up to 2.5 GHz



SMT PLUG RECEPTACLE

Radiall (1)

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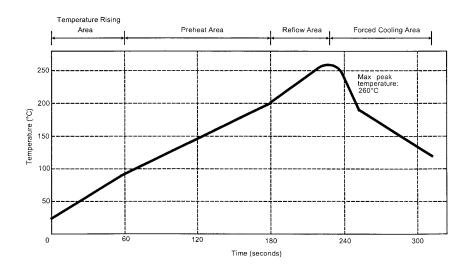
# SOLDER PROCEDURE OF MMBX RECEPTACLE IN INDUSTRIAL ENVIRONMENT

Deposit solder paste 'SnAg4Cu0.5' on mounting zone by screen printing application. We recommend a low residue flux.

We advise a thickness of 150 micromm (5.850 microinch). Verify that the edges of the zone are clean.

- Placement of the receptacle on the mounting zone with an automatic machine of 'pick and place' type. A video camera is recommended for positioning of the component. Adhesive agents must not be used on the receptacle.
- This process of soldering has been tested with convection oven. Below please find, the typical profile to use.
- The cleaning of printed circuit boards is not obliged.
- Verification of solder joints and position of the component by visual inspection.

## TEMPERATURE PROFILE



Parameter	Value	Unit
Temperature rising Area	1 - 4	°C/sec
Max Peak Temperature	260	°C
Max dwell time @260°C	10	sec
Min dwell time @235°C	20	sec
Max dwell time @235°C	60	sec
Temperature drop in cooling Area	-1 to - 4	°C/sec
Max dwell time above 100°C	420	sec



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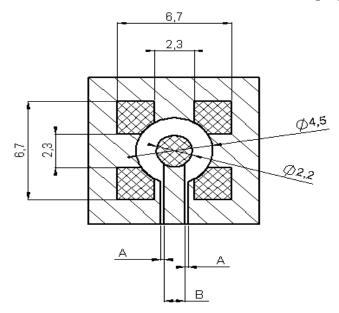
ISSUE **26-10-18C** 

SERIES MMBX

PART NUMBER **R223434000** 

## **MMBX SERIES INFORMATIONS**

## **PCB**



## **COPLANAR LINE**

Pattern and signal are on the same side The material of PCB is epoxy resin (FR4). (Er = 4.6)

The solder resist should be printed Except for the land pattern on the PCB



## **Pattern**



Land for solder paste

### APPLICATION 75Ω

### WITH B = 0.55mm

PCB thickness (mm)	Coplanar ligne A (mm)
0,8	0,350
1,0	0,360
1,2	0,365
1,6	0,375

### APPLICATION 50Ω

## WITH B = 1,2mm

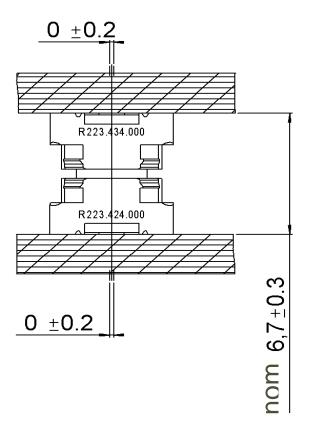
PCB thickness (mm)	Coplanar ligne A (mm)
0,8	0,190
1,0	0,200
1,2	0,205
1,6	0,210

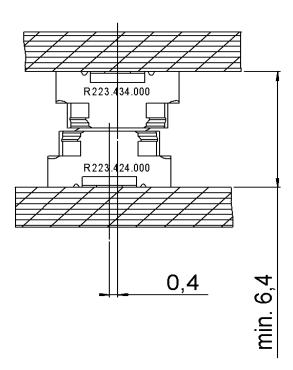


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## **MMBX SERIES INFORMATIONS**





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